ASSIGNMENT RE



EET Patents Only

To the Honorable Commissioner of Pale 138092	Date: June 17, 2002 Attorney Docket No. 5649-945			
Please record the attached original documents or copy thereof.				
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):			
Chang-hyun Cho Min-bee Cho Ki-nam Kim	Samsung Electronics Co., Ltd. 416 Maetan-dong, Paldal-gu Suwon-City, Kyungki-do Republic of Korea			
Additional name(s) of conveying party(ies) attached? Yes X No				
3. Nature of conveyance:				
X_ Assignment Merger Security Agreement Change of Name Other Execution Date: May 29, 2002	Additional name(s) & address(es) attached? Yes _X_ No			
4. Application Serial NoPatent No.				
If this document is being filed together with a new application, is: June 17, 2002 Additional numbers attached? Yes X No	the execution date of the application			
5. Name and address of party to whom correspondence	6. Total number of applications and patents involved: 1			
concerning document should be mailed: Laura M. Kelley Myers Bigel Sibley & Sajovec P. O. Box 37428 Polytick NC 27627	7. Total fee (37 CFR 3.41) \$40.00 X Enclosed Authorized to be charged to deposit account			
Raleigh NC 27627	8. Deposit account number: 50-0220			
DO NOT USE THIS SPACE				
9. Statement and signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Laura M. Kelley #48,441 Name of Person Signing Signature Total number of pages including cover sheet, attachments and document: 3				
10th number of pages mending cover sheet, attachments and doc	mion. 2			
1				

06/24/2002 STEUMEL1 00000015 10173373

04 FC:581

40.00 BP

ASSIGNMENT

THIS ASSIGNMENT, made by us, **Chang-hyun Cho**, citizen of Republic of Korea, residing at 405-306, Samik Apt., 708, Suseo-dong, Kangnma-gu, Seoul, Republic of Korea; **Minhee Cho**, citizen of the Republic of Korea, residing at 102, 1134-11, Bono3-dong, Ansan-city, Kyungki-do, Republic of Korea; and **Ki-nam Kim**, citizen of the Republic of Korea, residing at 108-502, Kkummaeul Life Apt., Pyunchon-dong, Dongan-gu, Anyang-city, Kyungki-do, Republic of Korea.

WHEREAS, we are the joint inventors of certain new and useful improvements in for which an application for United States Letters Patent has been filed, or is being filed concurrently, in the United States Patent and Trademark Office entitled METHOD PROVIDING OXIDE LAYERS HAVING REDUCED THICKNESSES AT CENTRAL PORTIONS

THEREOF AND RELATED DEVICES. We hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. ________, filed _______) the filing date and application number of said application when known or to file this Assignment concurrently with the application; and

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 416 Maetan-dong, Paldal-gu, Suwon-City, Kyungki-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold and by these presents do hereby sell, assign, transfer, and convey unto the said assignee, its successors and assigns, the entire right, title, and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues or other forms of protection thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted along with any term extensions thereon or therefor, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

Page 1 of 2

We hereby request that said Letters Patent be issued in accordance with this assignment.

We further covenant and agree that, at the time of the execution and delivery of these presents, we possess full title to the invention and application above-mentioned, and that we have the unencumbered right and authority to make this assignment.

We further covenant and agree to promptly communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors, or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns, and other legal representatives; and we hereby instruct, and further covenant and agree to bind our heirs, legal representatives, and assigns, to do same, without further compensation, but at the expense of said assignee or its representatives.

instruct, and further cover	nant and agree to bi	ind our heirs, legal rep	resentatives, and assigns	, to d
same, without further com	npensation, but at tl	he expense of said assi	ignee or its representative	es.
IN WITNESS WI	HEREOF, we have	hereunto set our hand	s and seals on this 29	_ day
of <u>May</u> , 20	02			
	Changhyun	Cho	(SEAL)	
	Chang-hyun	Cho 1 Cho	_ (
	Min-Hee	cho	(SEAL)	
	Min-hee Che	0	·····	
	Imam_	Kim	_ (SEAL)	
	' Ki-nam Kim	1		
Witnessed by:				
Date:				

Date:____